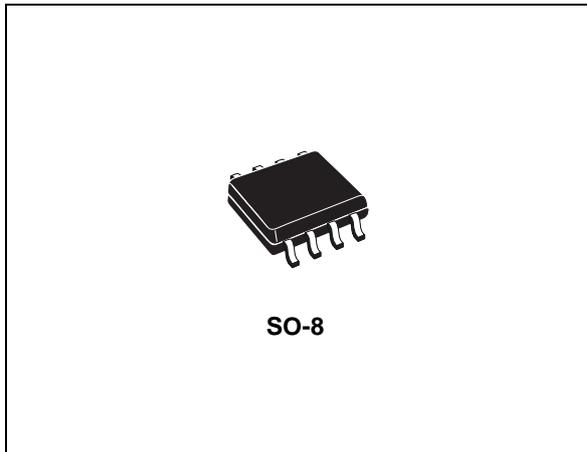
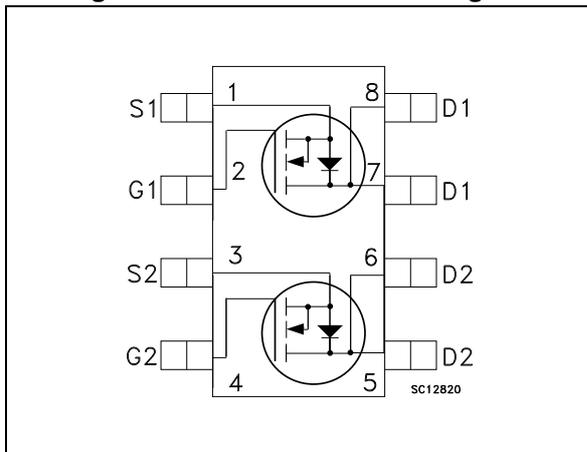


## Automotive-grade dual N-channel 60 V, 0.035 $\Omega$ typ., 5 A STripFET™ II Power MOSFET in an SO-8 package

Datasheet - production data



**Figure 1. Internal schematic diagram**



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STS5DNF60L	60 V	0.045 $\Omega$	5 A

- AEC-Q101 qualified
- Low threshold drive



### Applications

- Switching applications

### Description

This Power MOSFET has been developed using the STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

**Table 1. Device summary**

Order code	Marking	Package	Packing
STS5DNF60L	5DF60L	SO-8	Tape and reel

# Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	60	V
$V_{GS}$	Gate- source voltage	$\pm 15$	V
$I_D$	Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$	5	A
$I_D$	Drain current (continuous) at $T_{pcb} = 100\text{ }^\circ\text{C}$	3	A
$I_{DM}^{(1)}$	Drain current (pulsed)	16	A
$P_{TOT}^{(2)}$	Total dissipation at $T_{pcb} = 25\text{ }^\circ\text{C}$	2	W
$T_j$	Operating junction temperature range	-55 to 150	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		

1. Pulse width limited by safe operating area

2.  $P_{TOT} = 1.6\text{ W}$  for single operation

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-pcb}$	Thermal resistance junction-pcb <sup>(1)</sup>	62.5	$^\circ\text{C/W}$

1. When mounted on 1 inch<sup>2</sup> FR-4 board, 2 Oz Cu,  $t \leq 10\text{ s}$ , dual operation

## 2 Electrical characteristics

( $T_{CASE} = 25\text{ °C}$  unless otherwise specified)

**Table 4. On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 250\ \mu\text{A}$ , $V_{GS} = 0\ \text{V}$	60			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\ \text{V}$ , $V_{DS} = 60\ \text{V}$			1	$\mu\text{A}$
		$V_{GS} = 0\ \text{V}$ , $V_{DS} = 60\ \text{V}$ $T_C = 125\text{ °C}$ (1)			10	$\mu\text{A}$
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0\ \text{V}$ , $V_{GS} = \pm 15\ \text{V}$			$\pm 100$	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\ \mu\text{A}$	1	1.7	2.5	V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10\ \text{V}$ , $I_D = 2\ \text{A}$		0.035	0.045	$\Omega$
		$V_{GS} = 4.5\ \text{V}$ , $I_D = 2\ \text{A}$		0.045	0.055	$\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}$	Forward transconductance	$V_{DS} = 25\ \text{V}$ , $I_D = 2\ \text{A}$	-	25	-	S
$C_{iss}$	Input capacitance	$V_{DS} = 25\ \text{V}$ , $f = 1\ \text{MHz}$ , $V_{GS} = 0\ \text{V}$	-	1030	-	pF
$C_{oss}$	Output capacitance			140		pF
$C_{rss}$	Reverse transfer capacitance			40		pF
$Q_g$	Total gate charge	$V_{DD} = 48\ \text{V}$ , $I_D = 4\ \text{A}$ ,	-	15	-	nC
$Q_{gs}$	Gate-source charge	$V_{GS} = 4.5\ \text{V}$		4		nC
$Q_{gd}$	Gate-drain charge	(see <a href="#">Figure 13</a> )		4		nC

**Table 6. Switching times**

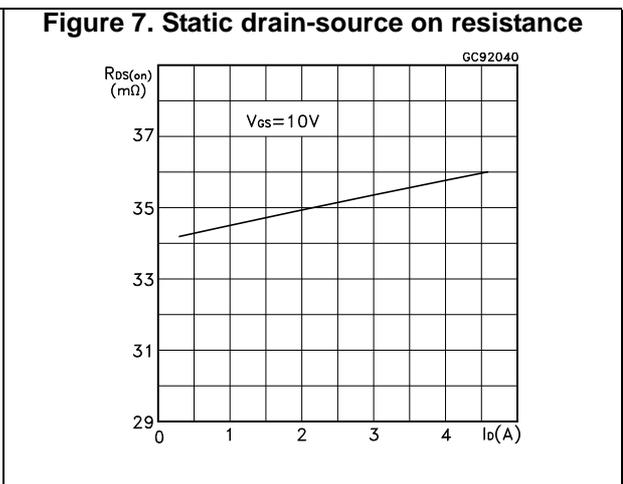
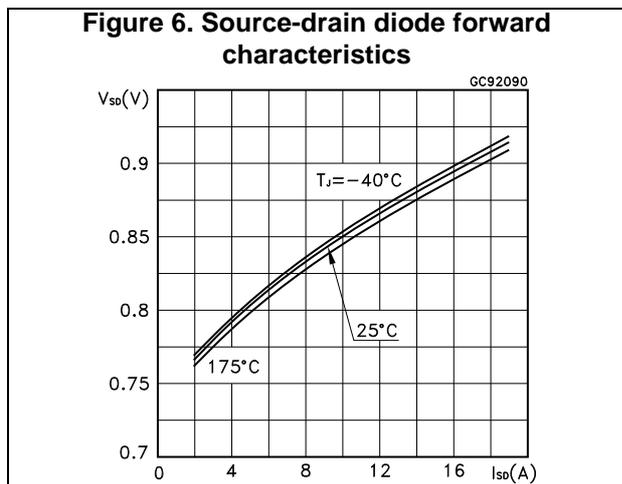
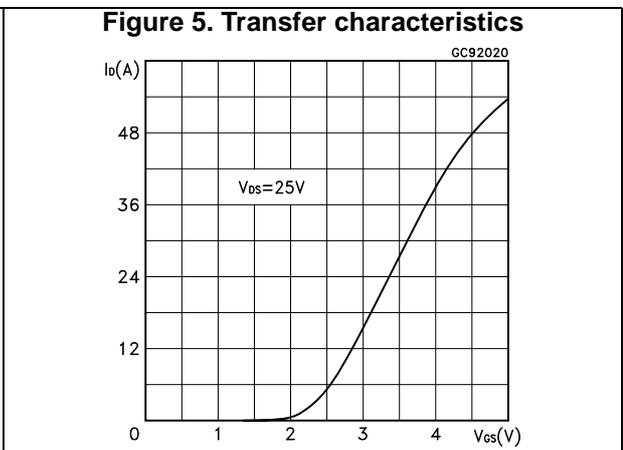
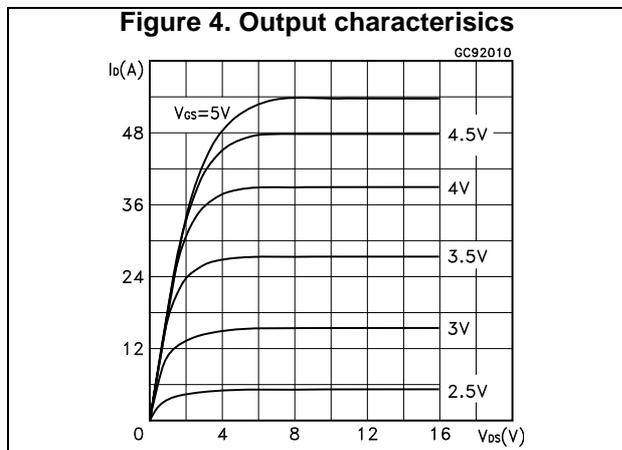
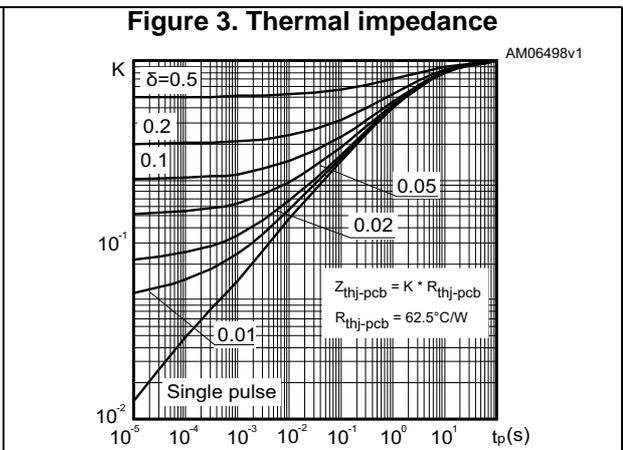
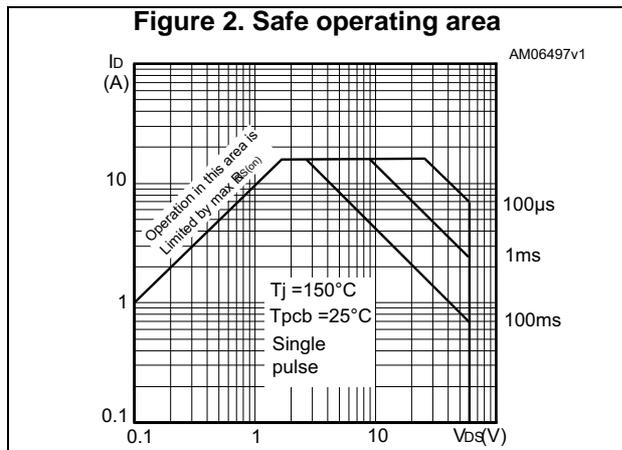
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$t_{d(off)}$	Turn-off delay time	$V_{DD} = 30\ \text{V}$ , $I_D = 2.2\ \text{A}$ , $R_G = 4.7\ \Omega$ , $V_{GS} = 10\ \text{V}$ (see <a href="#">Figure 12</a> and <a href="#">Figure 17</a> )		15		ns	
$t_r$	Rise time		-	28	-	ns	
$t_{d(off)}$	Turn-off delay time				45		ns
$t_f$	Fall time				10		ns

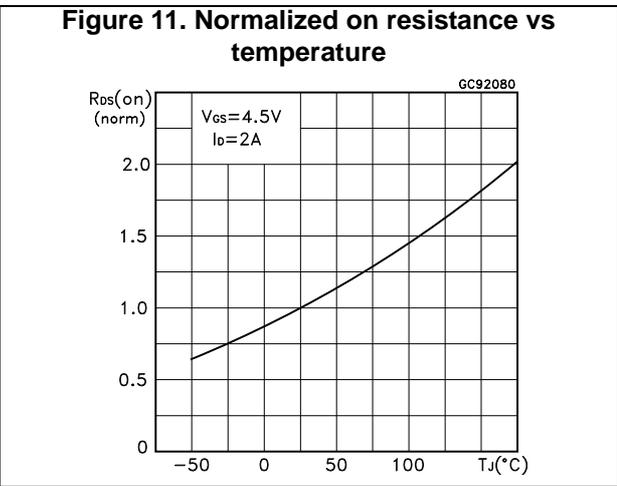
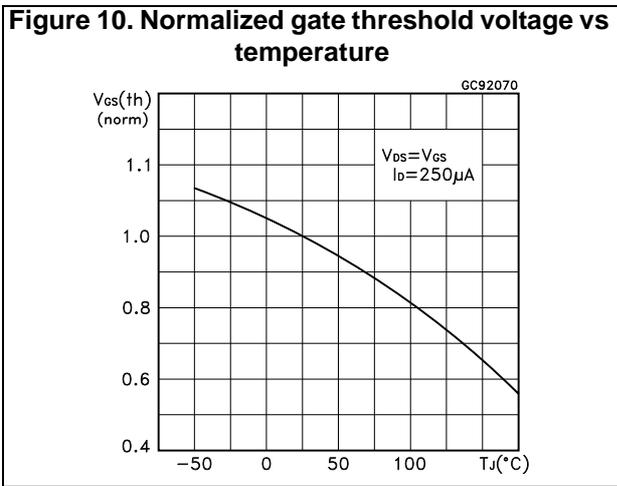
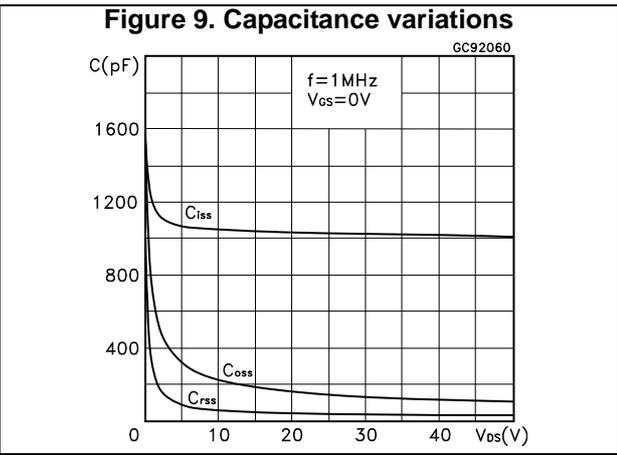
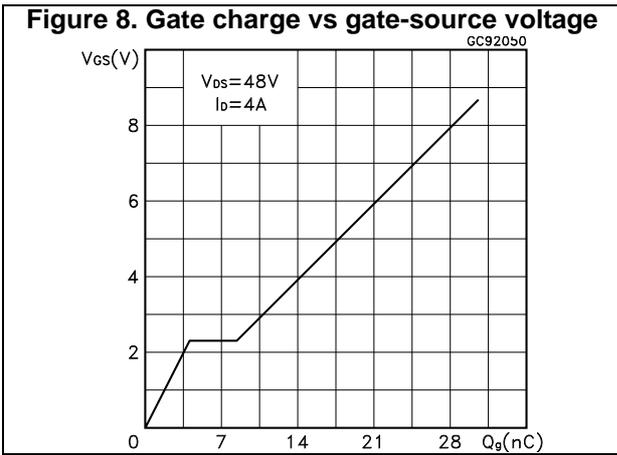
Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		5	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				16	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 4 \text{ A}$ , $V_{GS} = 0 \text{ V}$	-		1.2	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 4 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 20 \text{ V}$ (see <a href="#">Figure 14</a> )	-	85		ns
$Q_{rr}$	Reverse recovery charge			85		nC
$I_{RRM}$	Reverse recovery current			2		A

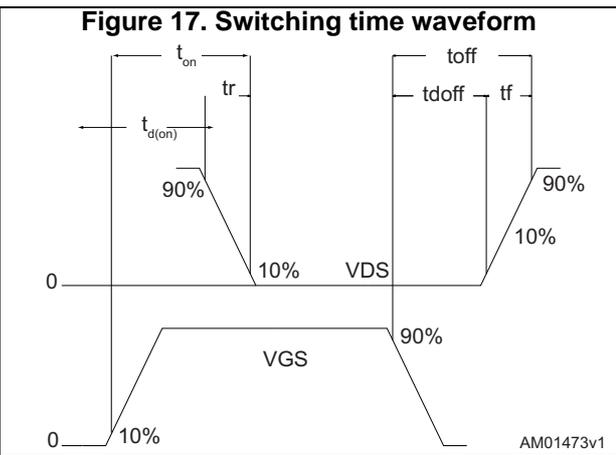
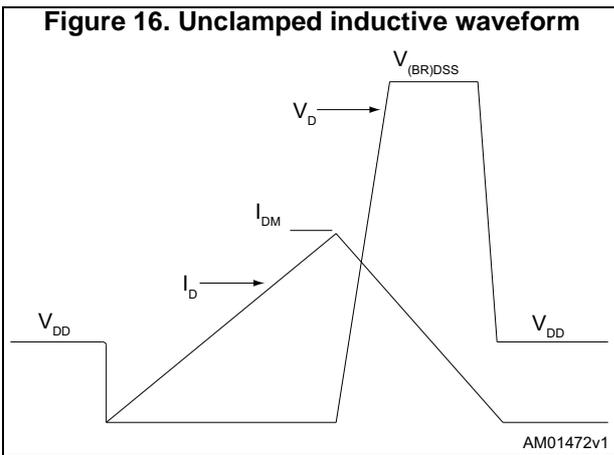
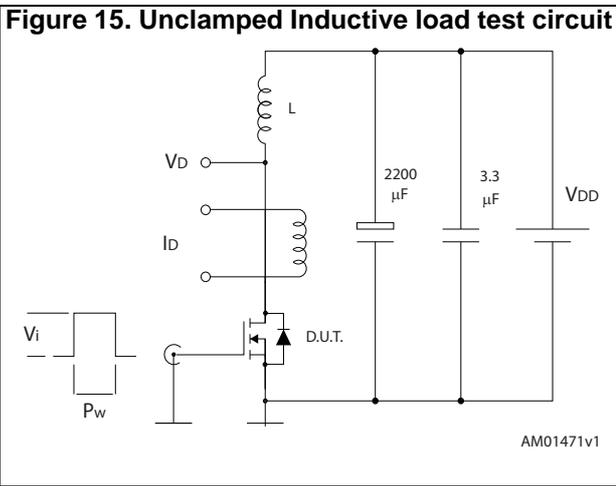
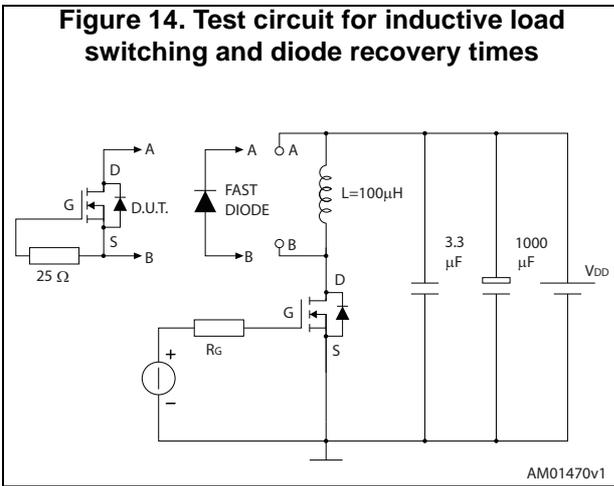
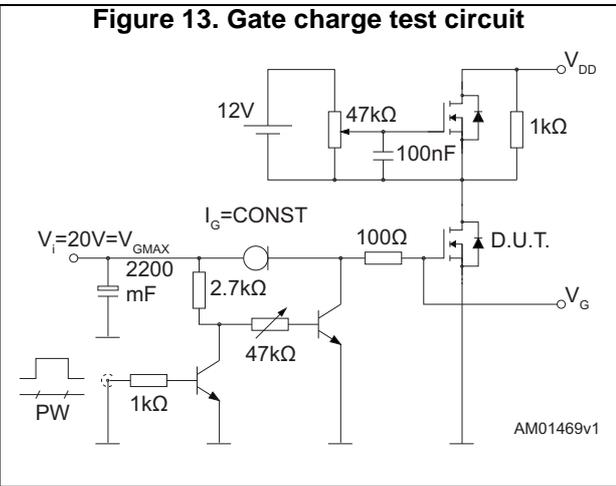
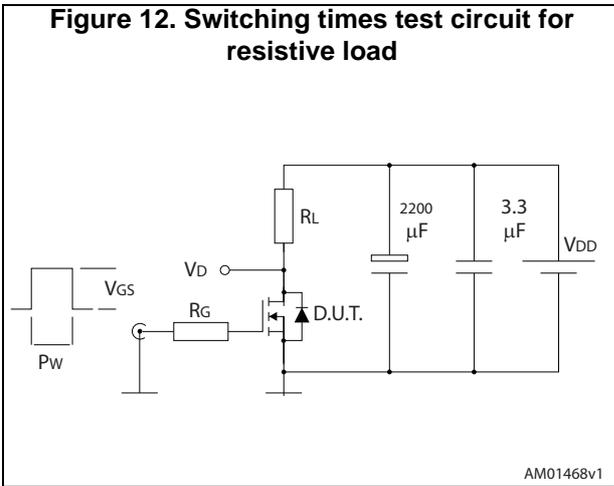
1. Pulse width limited by safe operating area
2. Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5 %

## 2.1 Electrical characteristics (curves)





### 3 Test circuits



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 SO-8 package information

Figure 18. SO-8 package outline

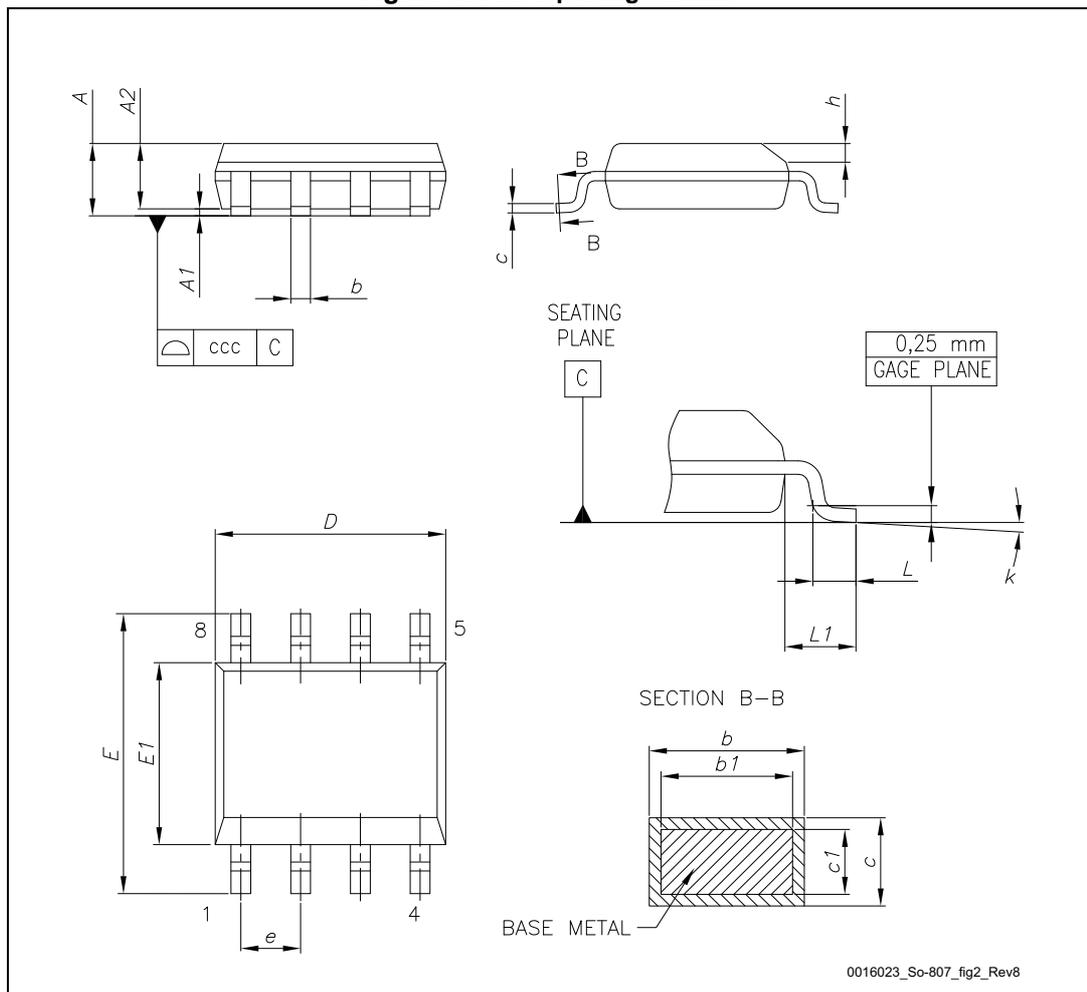
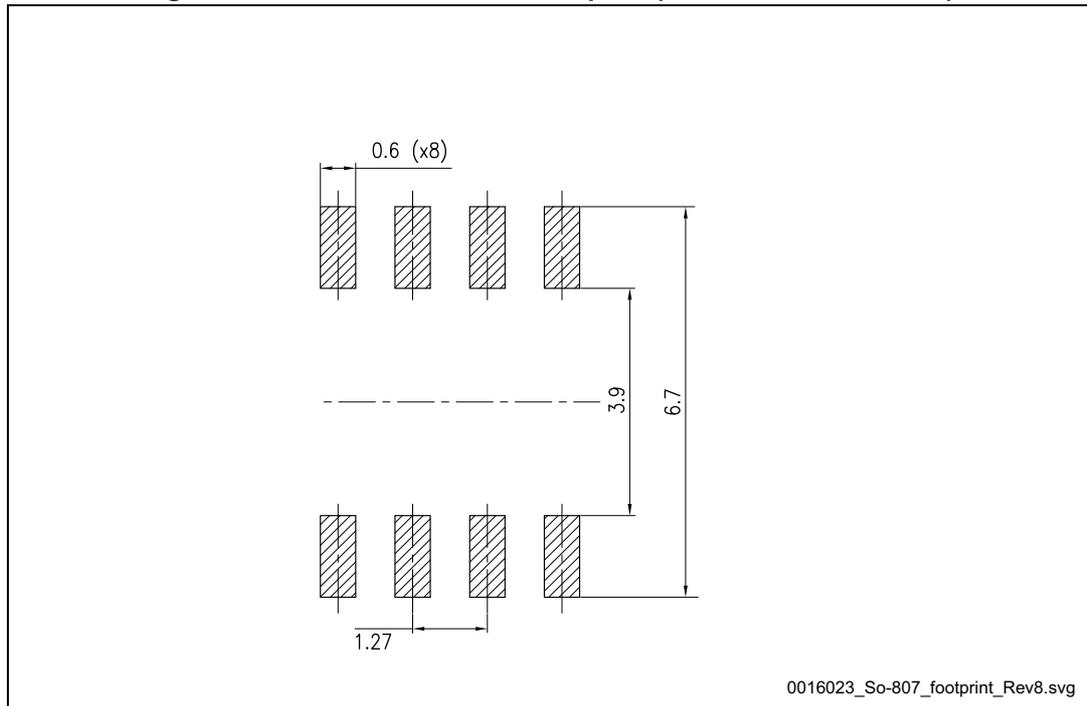


Table 8. SO-8 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
K	0°		8°
ccc			0.10

Figure 19. SO-8 recommended footprint (dimensions are in mm)



## 4.2 Packing information

Figure 20. Tape and reel dimension

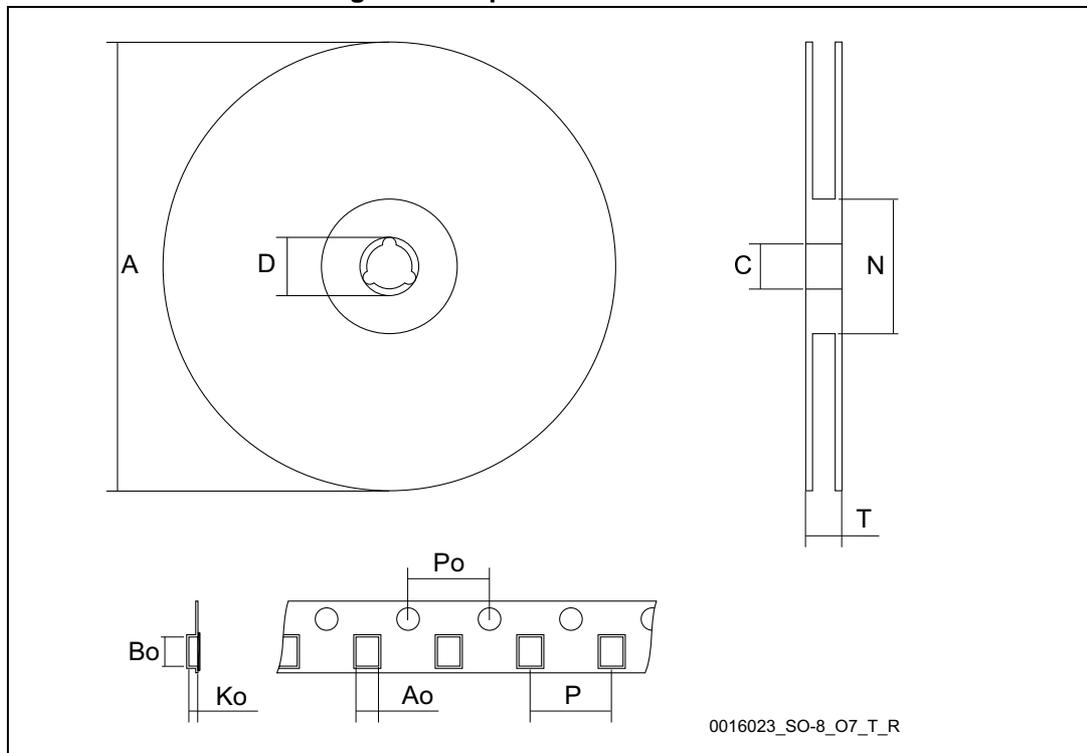


Table 9. SO-8 tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			330
C	12.8		13.2
D	20.2		
N	60		
T			22.4
Ao	8.1		8.5
Bo	5.5		5.9
Ko	2.1		2.3
Po	3.9		4.1
P	7.9		8.1

## 5 Revision history

Table 10. Revision history

Date	Revision	Changes
03-Mar-2008	1	First release
18-Mar-2010	2	<i>Figure 2: Safe operating area</i> and <i>Figure 3: Thermal impedance</i> have been changed.
17-Oct-2016	3	Updated title, features and description in cover page. Added AEC-Q101 qualified in the Features section. Updated <i>Package information</i> and <i>Packing information</i> . Minor text changes.

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